

## DTK6002SJ www.din-tek.jp

# N-Channel 60 V (D-S) Super Junction Power MOSFET

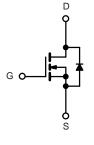
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>		
60	0.0021 at V <sub>GS</sub> = 10 V	190		
	0.0029 at V <sub>GS</sub> = 4.5 V	150		

#### FEATURES

- 175 °C Junction Temperature
- DT-Trench Power MOSFET
- Material categorization:







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ( $T_C = 1$	25 °C, unless othe	rwise noted)			
Parameter	Symbol	Limit	Unit		
Gate-Source Voltage	V <sub>GS</sub>	± 20	V		
Continuous Droin Current (T 175 °C)b	T <sub>C</sub> = 25 °C	L	190		
Continuous Drain Current (T <sub>J</sub> = 175 °C) <sup>b</sup>	T <sub>C</sub> = 100 °C	D	150 <sup>a</sup>		
Pulsed Drain Current		I <sub>DM</sub>	660	А	
Continuous Source Current (Diode Conduction)		۱ <sub>S</sub>	190 <sup>a</sup>	-	
Avalanche Current		I <sub>AS</sub>	189		
Single Avalanche Energy (Duty Cycle $\leq$ 1 %)	L = 0.1 mH	E <sub>AS</sub>	750	mJ	
Maximum Dawar Dissinction	T <sub>C</sub> = 25 °C	Р	235	w	
Maximum Power Dissipation	T <sub>C</sub> = 75 °C	P <sub>D</sub>	157	vv	
Operating Junction and Storage Temperature Range	•	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Mauinung lungting to Archingta	$t \le 10 \text{ sec}$	R <sub>thJA</sub>	10	15	°C/W
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		30	40	
Maximum Junction-to-Case		R <sub>thJC</sub>	0.55	1.0	

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c.  $t \leq 10$  s.

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<b>SPECIFICATIONS</b> ( $T_J = 25$	°C, unless o	otherwise noted)					
Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
Static	<u> </u>		1		<u> </u>		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	60			V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		2.5	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		V <sub>DS</sub> = 48 V, V <sub>GS</sub> = 0 V			1	μA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 48 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50		
		V <sub>DS</sub> = 48 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			250		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 V, V_{GS} = 10 V$	190			А	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0021	0.0029	Ω	
	Б	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		0.0027	0.0032		
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A, T <sub>J</sub> = 175 °C		0.0030	0.0036		
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A		0.0029	0.0039		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 48 V, I <sub>D</sub> = 20 A		45		S	
Dynamic							
Input Capacitance	C <sub>iss</sub>			8510		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V, V_{DS} = 48 V, f = 1 MHz$		1070			
Reverse Transfer Capacitance	C <sub>rss</sub>			95			
Total Gate Charge <sup>c</sup>	Qg			65	77	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 48 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		10			
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			6.5			
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			9			
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 48 \text{ V}, \text{ R}_{\text{L}} = 0.6 \Omega$ $\text{I}_{\text{D}} \cong 20 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 2.5 \Omega$		5		ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			52			
Fall Time <sup>c</sup>	t <sub>f</sub>			11			
Source-Drain Diode Ratings and Cha	aracteristics (	T <sub>C</sub> = 25 °C)					
Pulsed Current	I <sub>SM</sub>				660	А	
Diode Forward Voltage	$V_{SD}$	$I_{F} = 20 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 20 A, di/dt = 100 A/μs		43	100	ns	

Notes:

a. For design aid only; not subject to production testing.

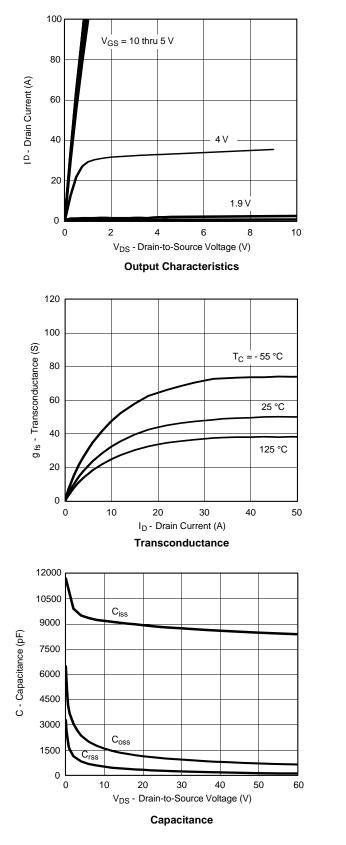
b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

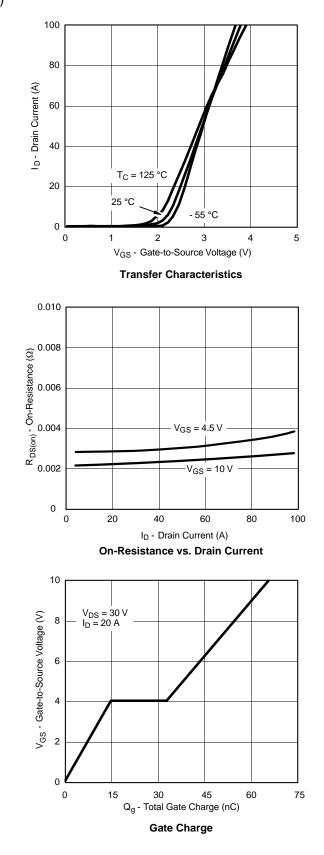
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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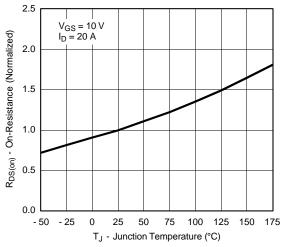
#### TYPICAL CHARACTERISTICS (25 °C unless noted)



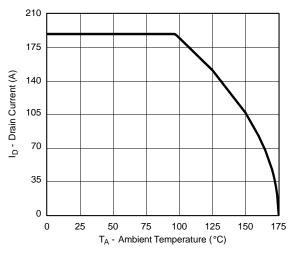


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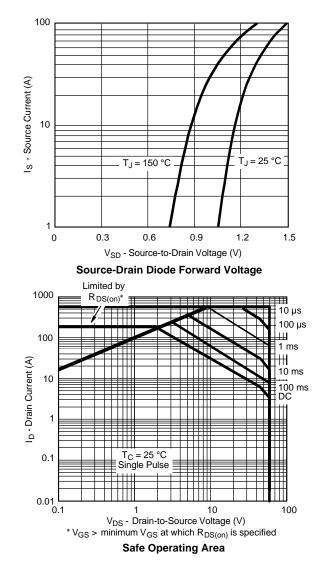
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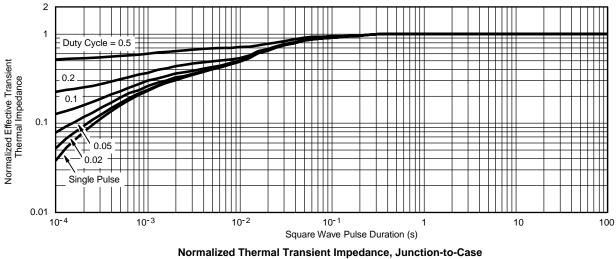


**On-Resistance vs. Junction Temperature** 



Maximum Drain Current vs. Ambient Temperature







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